



Laser Material Processing and Thermal Joining Process

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Message from the Guest Editor

Dear Colleagues,

This special issue addresses original scientific articles and detailed reviews related to important and novel developments in the field of laser material processing and thermal joining processes. Both fields are of great importance, and innovative approaches in process design and systems engineering are increasing the range of applications for cutting-edge industries, for example in electromobility and other branches. This special issue focusses specifically on contributions dealing with novelties in process design, material science and systems engineering and their interaction in the context of laser material processing and thermal joining processes

Dr. Klaus Schricker

Guest Editor





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Message from the Editor-in-Chief

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